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## Inventor Information for 10/658261

Inventor Name	City	State/Country
COHEN, ADAM L.	ARLINGTON	MASSACHUSETTS
GOLDEN, JOHN B.	NORTON	MASSACHUSETTS
VU, LIEM T.	NEEDHAM	MASSACHUSETTS

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US 20060134831 A1	US- PGPUB	20060622	Integrated circuit packaging using electrochemically fabricated structures	438/108	438/106; 438/121; 438/122	Cohen; Adam L. et al.
US 20060112550 A1	US- PGPUB	20060601	Microprobe tips and methods for making	29/884		Kim; Kieun et al.
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US 20060108678 A1	US- PGPUB	20060525	Probe arrays and method for making	257/690		Kumar; Ananda H. et al.
US 20060084265 A1	US- PGPUB	20060420	Method for electrochemically fabricating three-dimensional structures including pseudo- rasterization of data	438/670	438/671; 438/951	Cohen; Adam L. et al.
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US 20060006888 A1	US- PGPUB	20060112	Electrochemically fabricated microprobes	324/754		Kruglick; Ezekiel J. J. et al.
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US 20050215046 A1	US- PGPUB	20050929	Electrochemical fabrication methods incorporating dielectric materials and/or using dielectric substrates	438/619	438/628; 438/654; 438/669	Cohen, Adam L. et al.
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US 20050176238 A1	US- PGPUB	20050811	Electrochemical fabrication methods incorporating dielectric materials and/or using dielectric substrates	438/625	205/118; 438/622	Cohen, Adam L. et al.
US 20050173374 A1	US- PGPUB	20050811	Electrochemical fabrication methods incorporating dielectric materials and/or using dielectric substrates	216/41		Cohen, Adam L. et al.
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US 20050072681 A1	US- PGPUB	20050407	Multi-step release method for electrochemically fabricated structures	205/170	205/223	Cohen, Adam L. et al.
US 20050072454 A1	US- PGPUB	20050407	Microcombustor and combustion-based thermoelectric microgenerator	136/205	136/224	Cohen, Adam L. et al.
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US 20050054945 A1	US- PGPUB	20050310	Forceps and collection assembly with accompanying mechanisms and related methods of use	600/562		Cohen, Adam L. et al.

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US 20050023146 A1	US- PGPUB	20050203	Electrochemical fabrication method for producing multi-layer three-dimensional structures on a porous dielectric	205/118	205/135; 427/256; 427/443.1	Lembrikov, Pavel B. et al.
US 20050023145 A1	US- PGPUB	20050203	Methods and apparatus for forming multi-layer structures using adhered masks	205/118	205/135	Cohen, Adam L. et al.
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US 20040251142 A1	US- PGPUB	20041216	Methods of reducing interlayer discontinuities in electrochemically fabricated three-dimensional structures	205/223	205/115	Cohen, Adam L. et al.
US 20040230157 A1	US- PGPUB	20041118	Fluid delivery system and related methods of use	604/99.02		Perry, Stephen J. et al.
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US 20040134788 A1	US- PGPUB	20040715	Multi-cell masks and methods and apparatus for using such masks to form three-dimensional structures	205/135	205/170; 205/223	Cohen, Adam L. et al.
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US 20040129573 A1	US- PGPUB	20040708	Multi-cell masks and methods and apparatus for using such masks to form three-dimensional structures	205/170	205/183	Cohen, Adam L.
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US 20040065552 A1	US- PGPUB	20040408	Method for electrochemical fabrication	205/118	205/170	Cohen, Adam L.
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US 20040007468 A1	US- PGPUB	20040115	Multistep release method for electrochemically fabricated structures	205/118	205/223	Cohen, Adam L. et al.
US 20040004002 A1	US- PGPUB	20040108	Electrochemically fabricated structures having dielectric or active bases and methods of and apparatus for producing such structures	205/118	205/134	Thompson, Jeffrey A. et al.
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US 20010014409 A1	US- PGPUB	20010816	Article, method, and apparatus for electrochemical fabrication	428/606	204/280; 205/67; 205/70	Cohen, Adam L.
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